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# FDB0165N807L N-Channel PowerTrench<sup>®</sup> MOSFET 80 V, 310 A, 1.6 m $\Omega$

#### Features

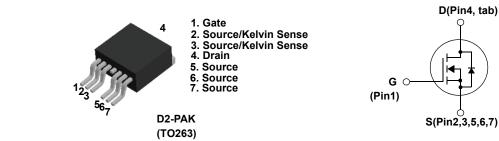
- Max r<sub>DS(on)</sub> = 1.6 mΩ at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 36 A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low <sup>r</sup>DS(on)
- High Power and Current Handling Capability
- RoHS Compliant

## **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance while maintaining superior ruggedness and switching performance for industrial applications.

## Applications

- Industrial Motor Drive
- Industrial Power Supply
- Industrial Automation
- Battery Operated Tools
- Battery Protection
- Solar Inverters
- UPS and Energy Inverters
- Energy Storage
- Load Switch



## **MOSFET Maximum Ratings** T<sub>C</sub> = 25 °C unless otherwise noted.

Symbol	Param	eter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage			80	V
V <sub>GS</sub>	Gate to Source Voltage			±20	V
	Drain Current -Continuous	T <sub>C</sub> = 25°C	(Note 5)	310	
I <sub>D</sub>	-Continuous	T <sub>C</sub> = 100°C	(Note 5)	220	Α
	-Pulsed		(Note 4)	1780	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	1083	mJ
D	Power Dissipation	T <sub>C</sub> = 25°C		300	14/
PD	Power Dissipation	T <sub>A</sub> = 25°C	(Note 1a)	3.8	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Tempera	ature Range		-55 to +175	°C

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	40	C/VV

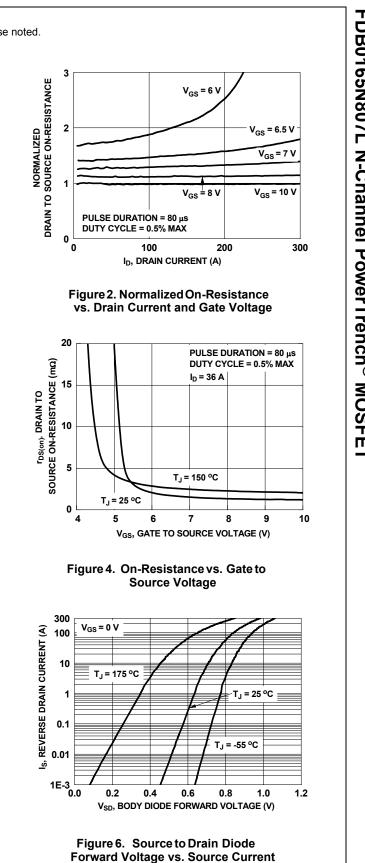
#### Package Marking and Ordering Information

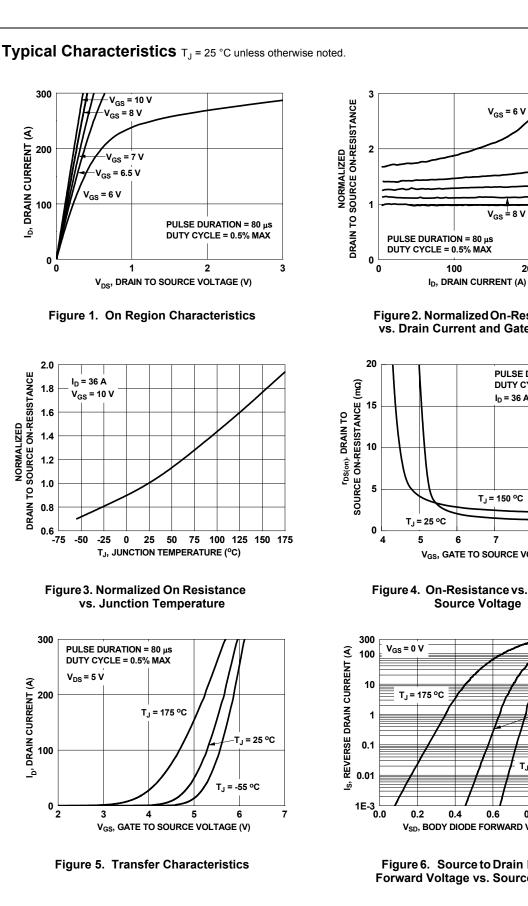
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB0165N807L	FDB0165N807L	D2-PAK-7L	330mm	24mm	800 units

BV <sub>DSS</sub> ΔBV <sub>DSS</sub> ΔΤ <sub>J</sub>	Drain to Source Breakdown Voltage         Breakdown Voltage Temperature					
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$ $\frac{I_{DSS}}{I_{GSS}}$	-					
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	80			V
	Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		38		mV/°C
I <sub>GSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V			1	μA
	Gate to Source Leakage Current	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V			±100	nA
On Chara	ICTERISTICS (Note 2)					
	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	2	2.9	4	V
$\frac{V_{GS(th)}}{\Delta V_{GS(th)}}$	Gate to Source Threshold Voltage		-	-	т 	-
$\frac{\Delta V GS(th)}{\Delta T_J}$	Temperature Coefficient	$I_D$ = 250 µA, referenced to 25 °C		-13		mV/°C
r <sub>no()</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 36 A		1.2	1.6	mΩ
r <sub>DS(on)</sub>		$V_{GS}$ = 10 V, I <sub>D</sub> = 36 A, T <sub>J</sub> = 150°C		2.0	2.7	1115.2
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 36 A		136		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			16900	23660	pF
C <sub>oss</sub>	Output Capacitance	$-V_{\rm DS} = 40$ V, $V_{\rm GS} = 0$ V,		2350	3290	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1 MHz		335	1050	pF
133	Gate Resistance					
Ra	Gale Resistance			3.3	1000	Ω
*				3.3	1000	
Switching	g Characteristics			I		Ω
Switching	g Characteristics Turn-On Delay Time			68	109	Ω
Switching t <sub>d(on)</sub> t <sub>r</sub>	<b>g Characteristics</b> Turn-On Delay Time Rise Time	$V_{DD} = 40 \text{ V}, \text{ I}_{D} = 36 \text{ A},$		68 104	109 166	Ω ns ns
Switching t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	V <sub>DD</sub> = 40 V, I <sub>D</sub> = 36 A, V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		68 104 123	109 166 197	Ω ns ns ns
Switching t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time			68 104 123 64	109 166 197 102	Ω ns ns ns
Switching t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge			68 104 123 64 217	109 166 197	ns ns ns ns nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub>	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge	V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		68 104 123 64 217 75	109 166 197 102	ns ns ns nC nC
Switching t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{DD} = 40 \text{ V}, \text{ I}_{D} = 36 \text{ A},$		68 104 123 64 217	109 166 197 102	ns ns ns ns nC
Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$ $Q_{gs}$ $Q_{gd}$	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{DD} = 40 \text{ V}, \text{ I}_{D} = 36 \text{ A},$		68 104 123 64 217 75	109 166 197 102	ns ns ns nC nC
Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$ $Q_{gs}$ $Q_{gd}$	g CharacteristicsTurn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate ChargeGate to Source Gate ChargeGate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ - V <sub>DD</sub> = 40 V, I <sub>D</sub> = 36 A, - V <sub>GS</sub> = 10 V		68 104 123 64 217 75	109 166 197 102	ns ns ns nC nC
Switching t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sou	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics	$V_{GS} = 10 \text{ V},  \text{R}_{GEN} = 6 \Omega$ $V_{DD} = 40 \text{ V},  \text{I}_{D} = 36 \text{ A},$ $V_{GS} = 10 \text{ V}$ de Forward Current		68 104 123 64 217 75	109 166 197 102 304	Ω ns ns ns nC nC
Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$ $Q_{gs}$ $Q_{gd}$ Drain-Sou	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Gate Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics         Maximum Continuous Drain to Source Diode	$V_{GS} = 10 \text{ V},  \text{R}_{GEN} = 6 \Omega$ $V_{DD} = 40 \text{ V},  \text{I}_{D} = 36 \text{ A},$ $V_{GS} = 10 \text{ V}$ de Forward Current		68 104 123 64 217 75	109 166 197 102 304 310	Ω ns ns ns nC nC nC
Switching t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sou I <sub>S</sub> I <sub>SM</sub>	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics Maximum Continuous Drain to Source Diode Maximum Pulsed Drain to Source Diode Fe	$V_{GS} = 10 \text{ V},  \text{R}_{GEN} = 6 \Omega$ $V_{DD} = 40 \text{ V},  \text{I}_{D} = 36 \text{ A},$ $V_{GS} = 10 \text{ V}$ de Forward Current prward Current		68 104 123 64 217 75 38	109 166 197 102 304 310 1780	Ω ns ns ns nC nC nC A A

4. Pulsed Id please refer to Figure 10 "Forward Bias Safe Operating Area" for more details.

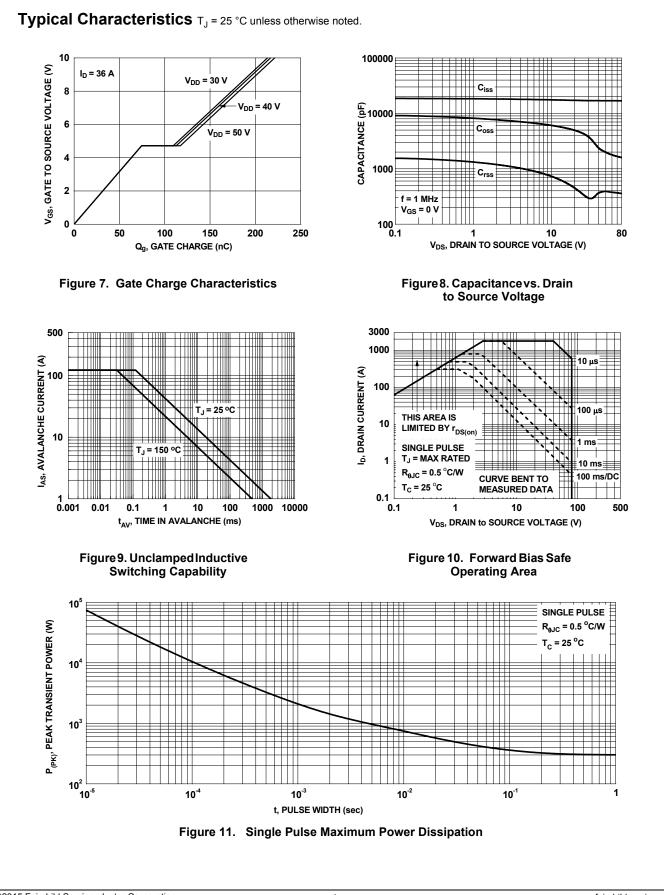
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.



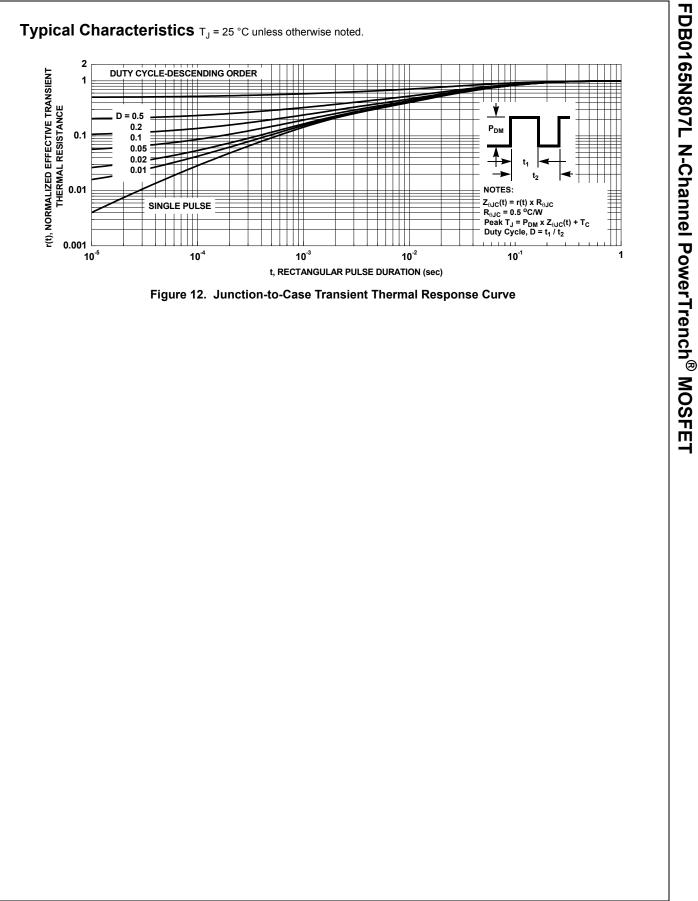


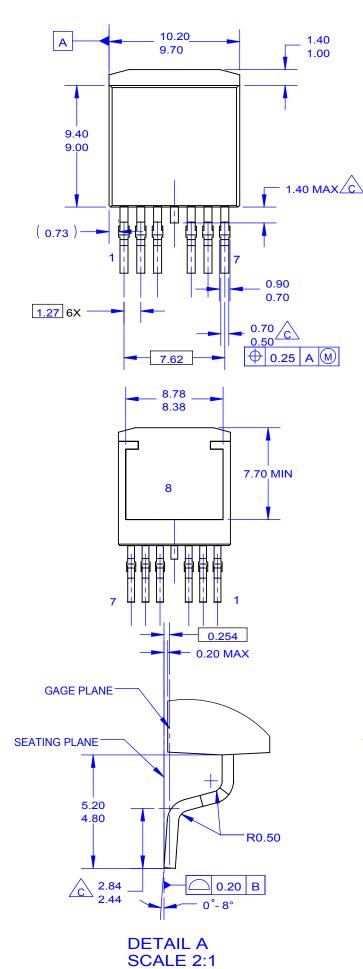
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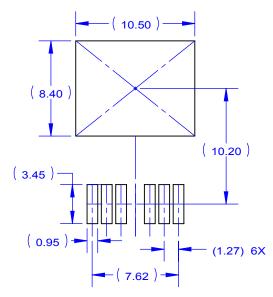
NORMALIZED



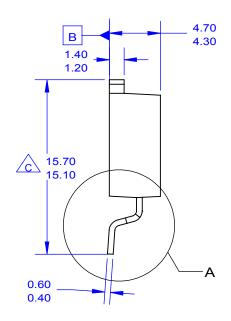
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#### LAND PATTERN RECOMMENDATION



#### NOTES:

- A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED.
   B. ALL DIMENSIONS ARE IN MILLIMETERS.
- OUT OF JEDEC STANDARD VALUE. D. DIMENSION AND TOLERANCE AS PER ASME
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  - F. LAND PATTERN RECOMMENDATION PER IPC. TO127P1524X465-8N.
  - G. DRAWING FILE NAME: TO263A07REV5.

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